

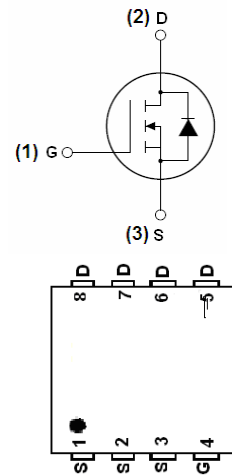
General Features

VDSS	RDS(ON) @10V (typ)	RDS(ON) @4.5V (typ)	ID
60V	6.8 mΩ	9.5 mΩ	45A

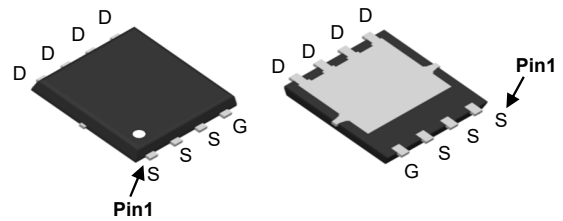
- Split Gate Trench Power MV MOSFET technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- Optimized for fast-switching applications
- RoHS Compliant

Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Industrial and Motor Drive applications



Top View



DFN 3x3-8L

Ordering Information

Part Number	Marking	Case	Packaging
GT45N06	GT45N06	DFN3*3-8L	3000pcs/Reel

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted					
Parameter		Symbol	Maximum		Units
Drain-Source Voltage		V_{DS}	60		V
Gate-Source Voltage		V_{GS}	± 20		V
Continuous Drain Current ^G	$T_A=25^\circ\text{C}$	I_D	45		A
	$T_A=100^\circ\text{C}$		25		
Pulsed Drain Current ^C		I_{DM}	80		A
Avalanche energy $L=0.5\text{mH}$ ^C		E_{AS}	180		mJ
Power Dissipation ^A	$T_A=25^\circ\text{C}$	P_{DSM}	50		W
	$T_A=100^\circ\text{C}$		20		
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150		$^\circ\text{C}$
Thermal Characteristics					
Parameter		Symbol	Maximum		Units
Maximum Junction-to-Ambient ^A	$t \leq 10\text{s}$	$R_{\theta JA}$	18	22	$^\circ\text{C/W}$
	Steady-State		55	72	
Maximum Junction-to-Case		$R_{\theta JC}$	2.1	2.5	$^\circ\text{C/W}$

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	60	65		V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.1	1.7	2.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A V _{GS} =4.5V, I _D =20A		6.8 9.5	8.2 12.0	mΩ
g _{FS}	Diode Forward Voltage	V _{DS} =5V, I _D =20A	30			S
V _{SD}	Diode Forward Voltage	I _S =20A, V _{GS} =0V		0.85	0.99	V
I _S	Maximum Body-Diode Continuous Current ^G				53	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, f=1MHz		1988		pF
C _{oss}	Output Capacitance			470		pF
C _{rss}	Reverse Transfer Capacitance			14		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		1.6		Ω
SWITCHING PARAMETERS						
Q _{g(10V)}	Total Gate Charge	V _{GS} =10V, V _{DS} =30V, I _D =20A		31		nC
Q _{g(4.5V)}	Total Gate Charge			16		nC
Q _{gs}	Gate Source Charge			6		nC
Q _{gd}	Gate Drain Charge			5		nC
t _{D(on)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =15V, R _L =2.5Ω, R _{GEN} =3Ω		10.5		ns
t _r	Turn-on Rise Time			4.5		ns
t _{D(off)}	Turn-off Delay Time			29.5		ns
t _f	Turn-off Fall Time			8		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =20A, di/dt=500A/μs		17		ns
Q _{rr}	Body Diode Reverse Recovery charge	I _F =20A, di/dt=500A/μs		58		nC

A. The value of R_{θJA} is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The Power dissipation P_{D(SM)} is based on R_{θJA} ≤ 10s and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Single pulse width limited by junction temperature T_{J(MAX)}=150° C.

D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

G. The maximum current rating is package limited.

Typical Performance Characteristics

Fig 1: Output Characteristics

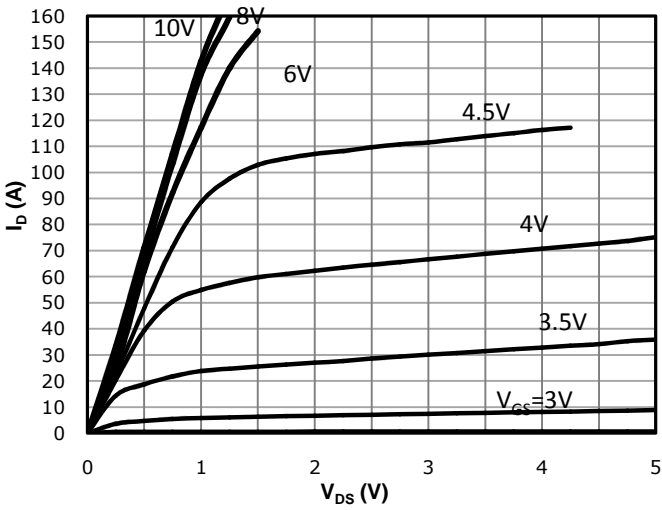


Fig 2: Transfer Characteristics

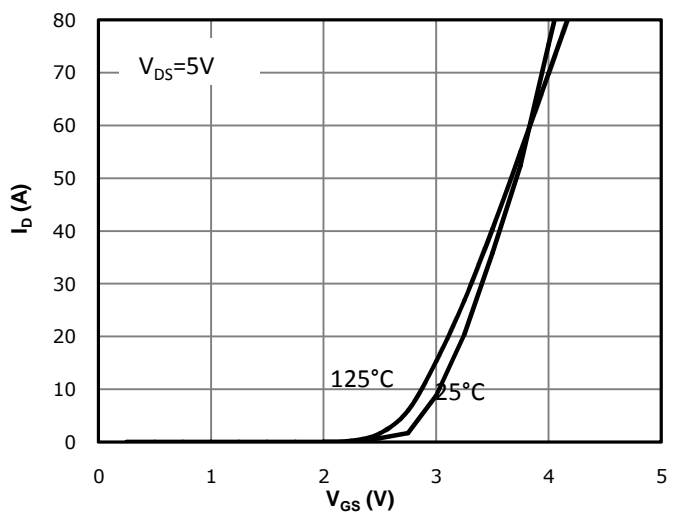


Fig 3: Rds(on) vs Drain Current and Gate Voltage

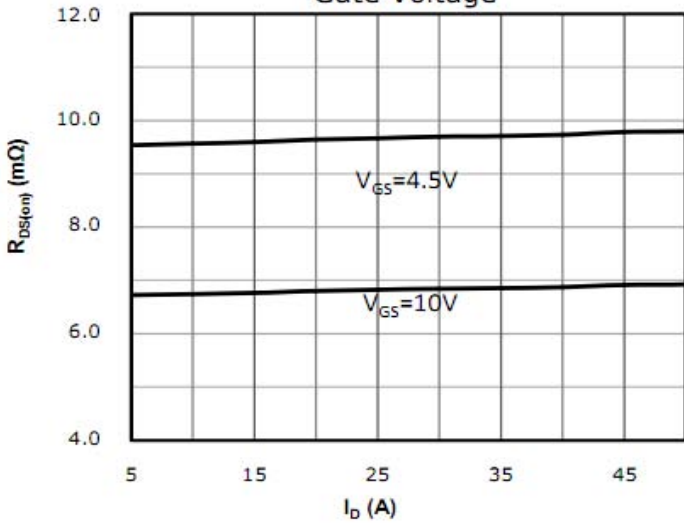


Fig 4: Rds(on) vs Gate Voltage

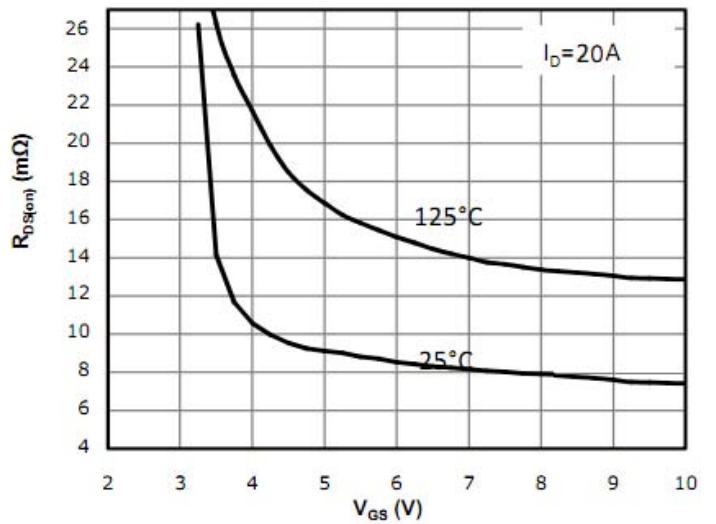


Fig 5: Rds(on) vs. Temperature

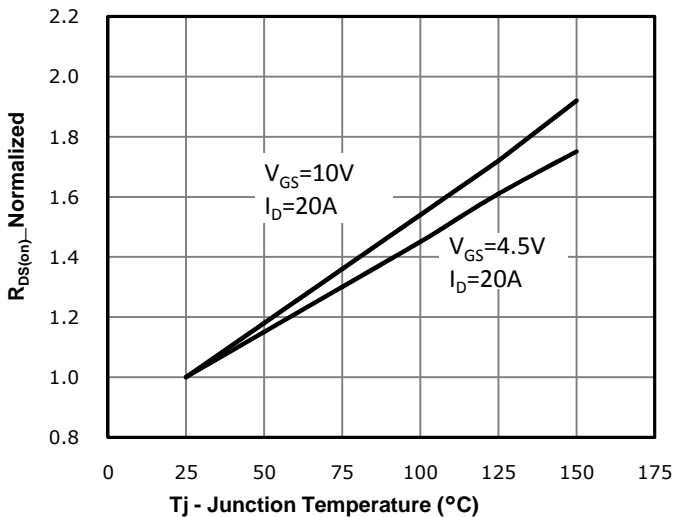


Fig 6: Capacitance Characteristics

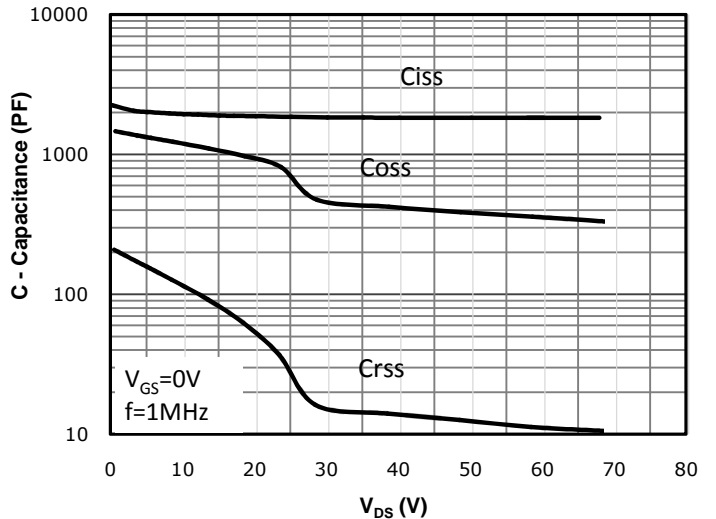


Fig 7: Gate Charge Characteristics

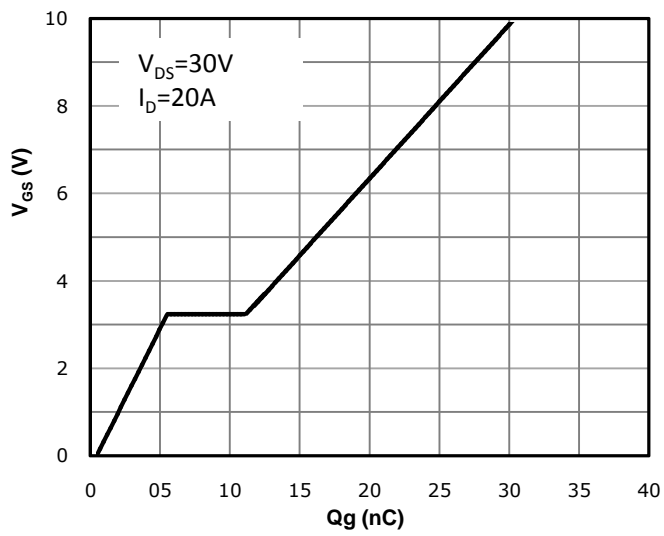


Fig 8: Body-diode Forward Characteristics

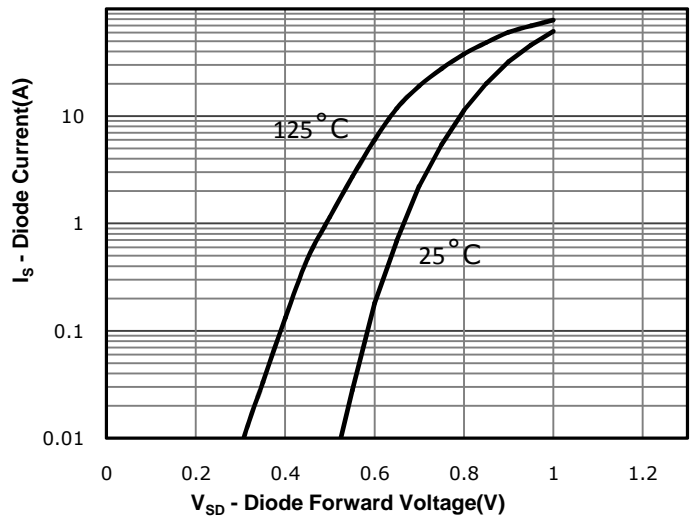


Fig 9: Power Dissipation

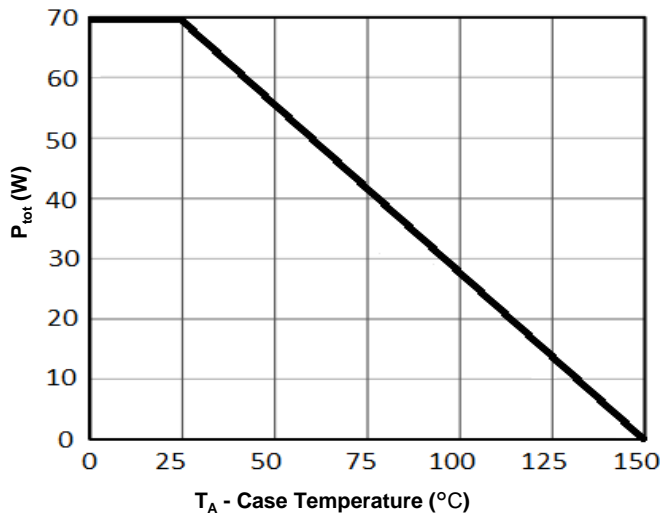


Fig 10: Drain Current Derating

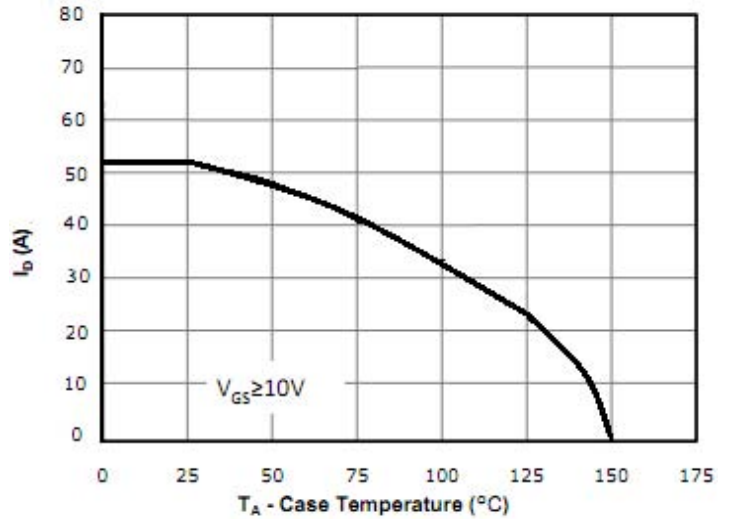


Figure A: Gate Charge Test Circuit & Waveforms

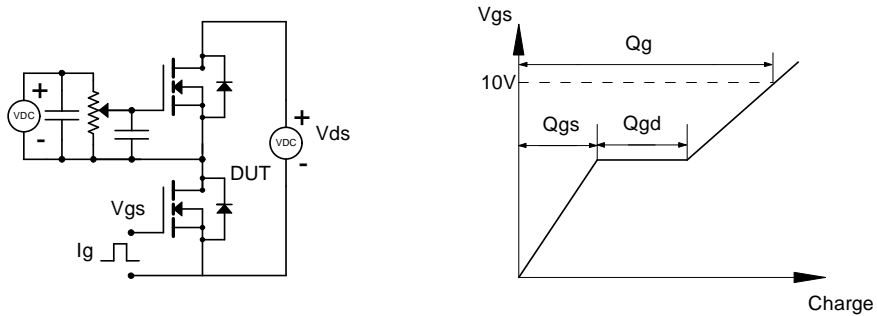


Figure B: Resistive Switching Test Circuit & Waveforms

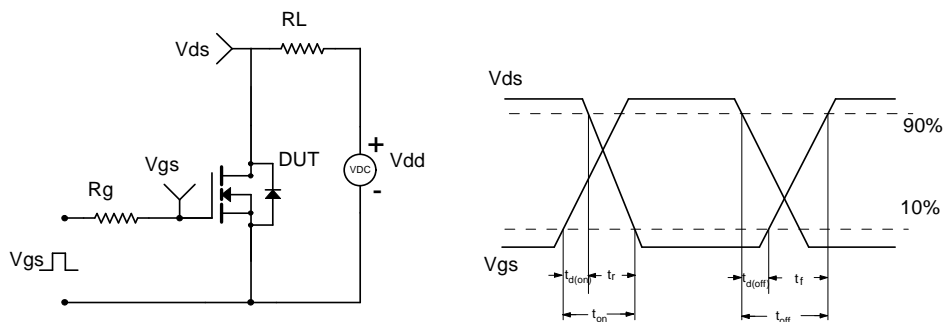


Figure C: Unclamped Inductive Switching (UIS) Test

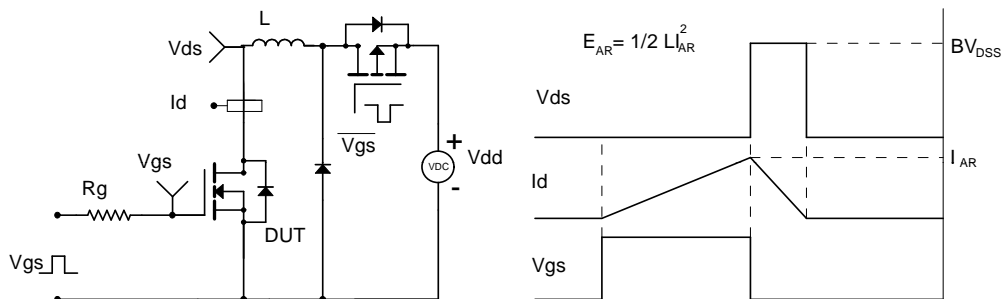
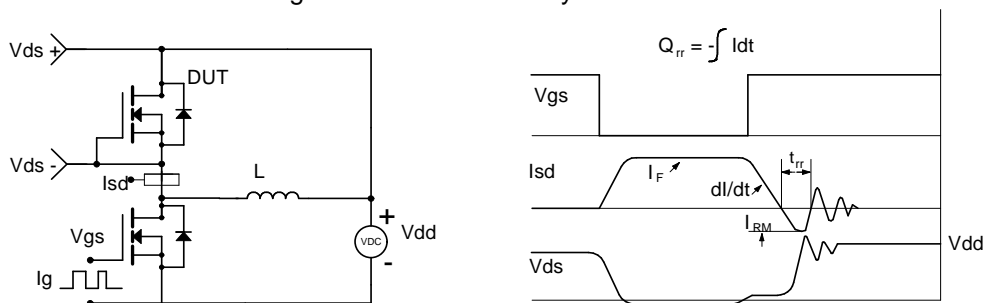
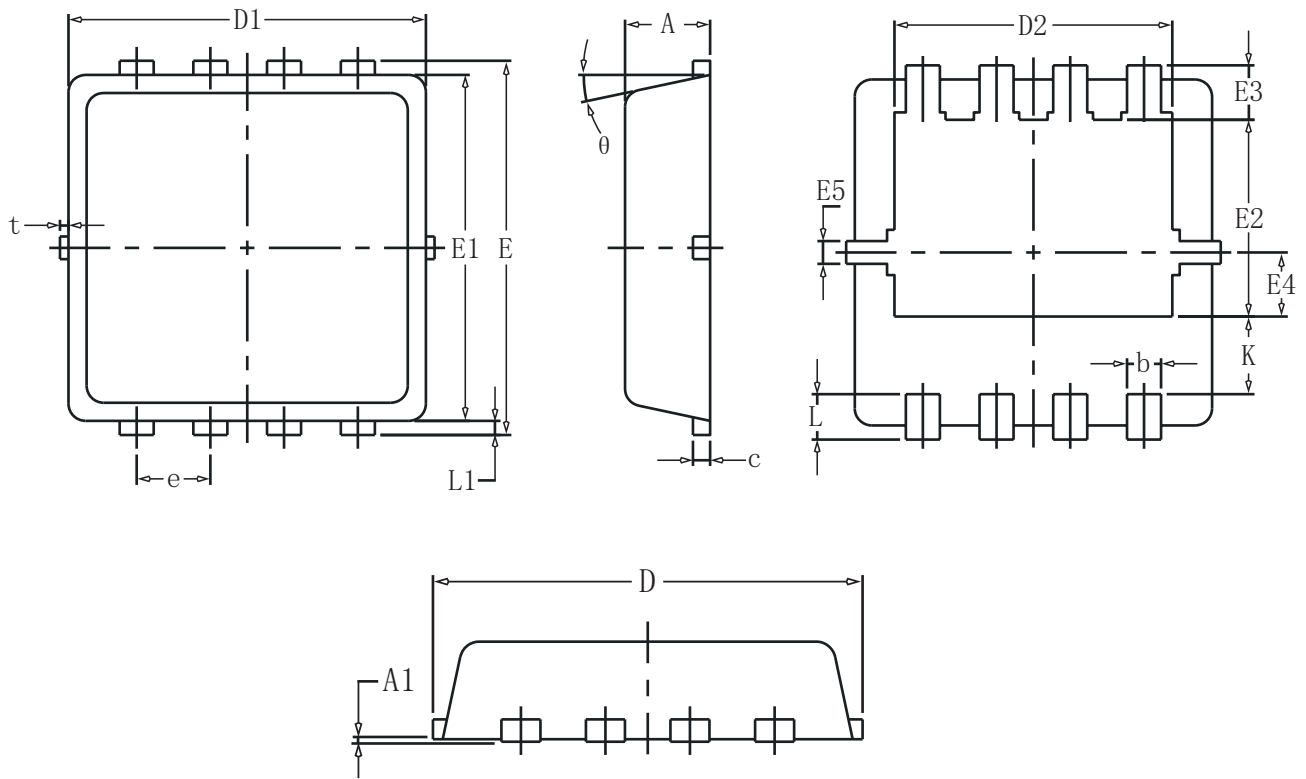


Figure D: Diode Recovery Test Circuit & Waveforms



DFN3X3-8L Package information



SYMBOL	COMMON		
	MM		
	MIN	NOM	MAX
A	0.70	0.75	0.85
A1	-	-	0.05
b	0.20	0.30	0.40
c	0.10	0.152	0.25
D	3.15	3.30	3.45
D1	3.00	3.15	3.25
D2	2.29	2.45	2.65
E	3.15	3.30	3.45
E1	2.90	3.05	3.20
E2	1.54	1.74	1.94
E3	0.28	0.48	0.65
E4	0.37	0.57	0.77
E5	0.10	0.20	0.30
e	0.60	0.65	0.70
K	0.59	0.69	0.89
L	0.30	0.40	0.50
L1	0.06	0.125	0.20
t	0	0.075	0.13
θ	10°	12°	14°

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